

RS135N170T

N Channel MOSFET

Lead Free Package and Finish

Applications:

•DC-DC converter	

•Portable Equipment

•Power management

Features:

•Low Reverse transfer capacitances

Package

TO-220

•Fast switching speed

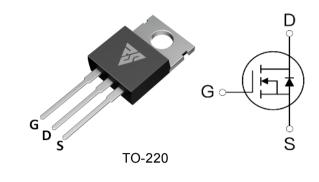
Ordering Information

Part Number

RS135N170T

•Low Gate Charge and RDS(on)

ID RDS(ON)(Typ) VDSS 174A 3.0mΩ 135V



Pb

Not to Scale

Absolute Maximun Ratings Tc=25 unless otherwise specified

Marking RS135N170T

Symbol	Parameter	RS135N170T	Units
VDSS	Drain-to-Source Voltage	135	V
	Continuous Drain Current TC = 25 °C	174	
ID	Continuous Drain Current TC = 100 °C	105	А
ldм	Pulsed Drain Current	640	
VGS	Gate-to-Source Voltage	±20	V
EAS Single Pulse Avalanche Engergy L=0.5mH VDD=70V RG=25ΩTJ=25		1225	mJ
IAR	Single pulse avalanche current	70	A
PD	Total Power Dissipation @ TC=25	250	W
	Maximum Temperature for Soldering		
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds	300 260	
TJ and TSTG Operating Junction and Storage Temperature Range		-55 to 150	

* Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the Absolute Maximum Ratings" Table may cause permanent damage to the device.

Thermal Resistance

Symbol	Parameter	RS135N170T	Units	Test Conditions
R0JC	Junction-to-Case	0.5	/ W	Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of +150
RθJA	Junction-to-Ambient	60		1 cubic foot chamber, free air.



OFF Characteristics TJ=250 unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain-to-source Breakdown Voltage	135			V	Vgs=0V,ID=250µA
ldss	Drain-to-Source Leakage Current			1.0	μA	VDS=135V,VGS=0V
loss	Gate-to-Source Forward Leakage			100	~ ^	Vgs=20V ,Vds=0V
IGSS	Gate-to-Source Reverse Leakage			- 100	nA	VGS=-20V ,VDS=0V

ON Characteristics TJ=25C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
RDS(on)	Static Drain-to-Source On-Resistance (Note*2)		3.0	3.6	mΩ	Vgs=10V,Id=20A
Vgs(TH)	Gate Threshold Voltage	2.5		3.5	V	Vgs=Vds,Id=250µA

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn-on Delay Time		25			VDS=70V
trise	Rise Time		33		nS	ID=20A
td(OFF)	Turn-OFF Delay Time		95	-	113	Vgs=10V
tfall	Fall Time		75			Rg=5Ω

Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance		8362			Vgs=0V
Coss	Output Capacitance		863		pF	VDS=70V
Crss	Reverse Transfer Capacitance		14.2			f=1.0MHz
Qg	Total Gate Charge		138			VDS=70V
Qgs	Gate-to-Source Charge		34		nC	ID=20A
Qgd	Gate-to-Drain("Miller") Charge		32			VGS=10V



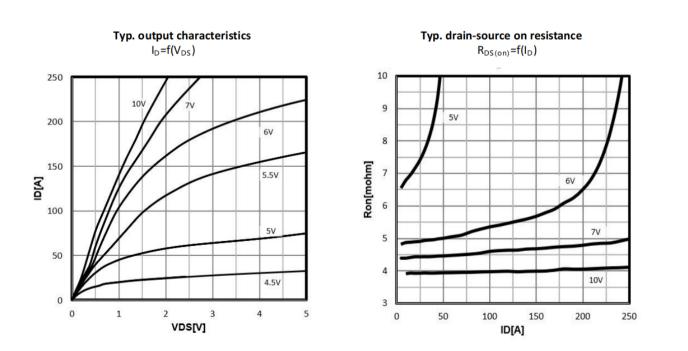
Source-Drain Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
ls	Continuous Source Current			174	Α	Integral pn-diode
lsм	Maximum Pulsed Current			640	Α	in MOSFET
Vsd	Diode Forward Voltage			1.2	V	Is=20A,VGs=0V
trr	Reverse Recovery Time		130		nS	VGS=0V
Qrr	Reverse Recovery Charge		500		nC	Is=20A,di/dt=100A/µs

Notes:

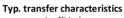
- *1. Repetitive rating; pulse width limited by maximum junction temperature.
- *2.Pulse Test: Pulse width \leq 300µs, Duty Cycle \leq 1%

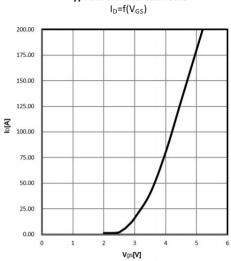
Typical Feature curve



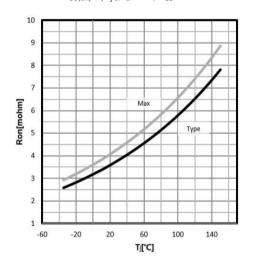


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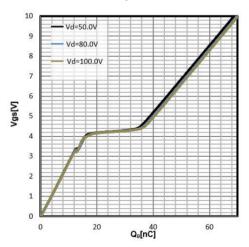


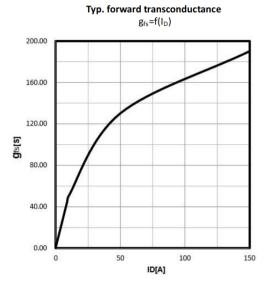


Drain-source on-state resistance $R_{DS(on)}=f(T_j)$; $I_D=80A$; $V_{GS}=10V$

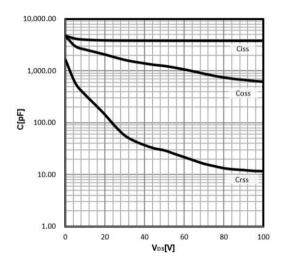


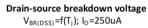


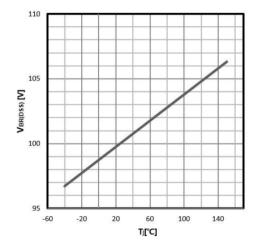




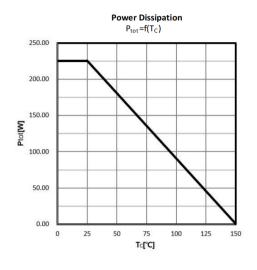
Typ. capacitances C =f(V_{DS}); V_{GS}=0V; f =1MHz









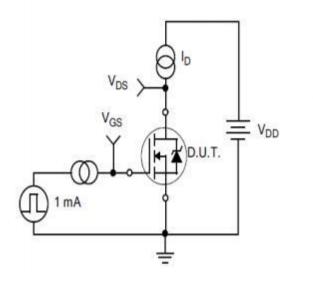


Safe operating area $l_D = f(V_{DS})$

Hax. transient thermal impedance $L_{th,c}=f(t_p)$



Test Circuits and Waveforms



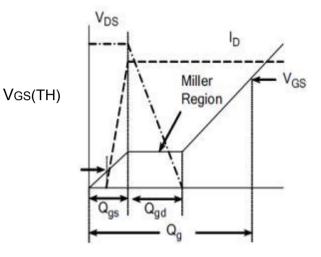


Figure A. Gate Charge Test Circuit

Figure B. Gate Charge Waveform

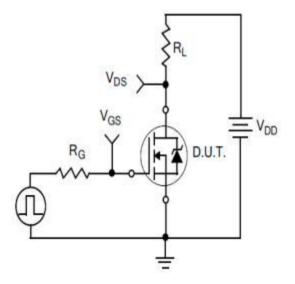


Figure C. Resistive Switching Test Circuit

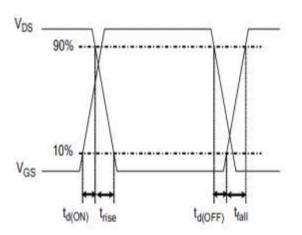
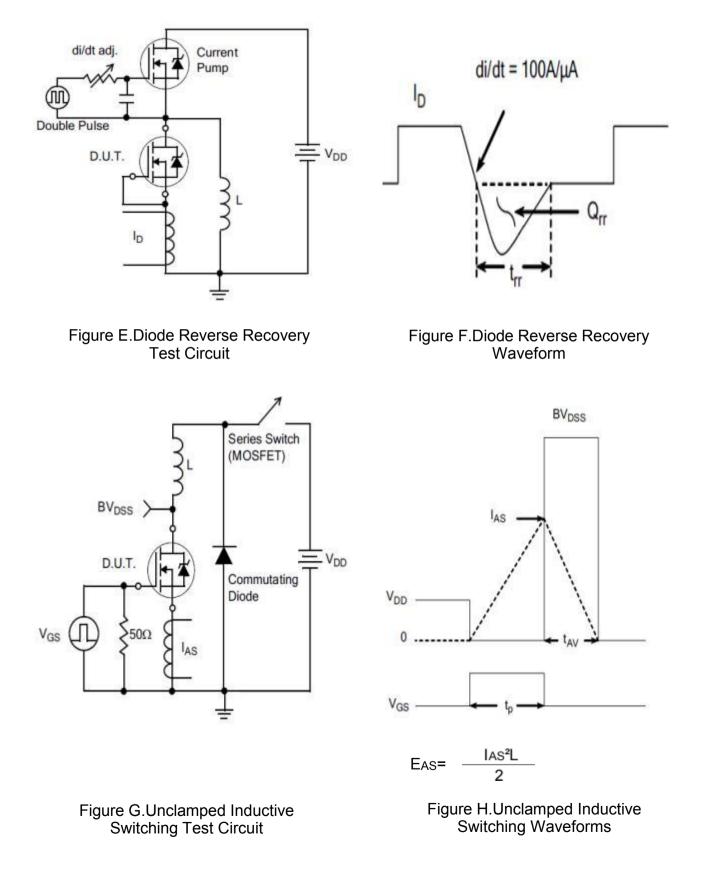


Figure D. Resistive Switching Waveforms

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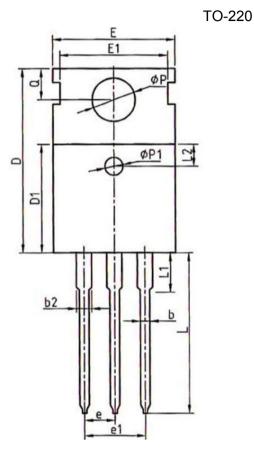
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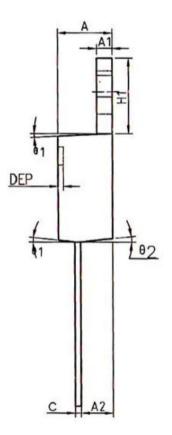


Unit:mm

Package outline drawing



	mth	m -m	
-	 		
	_	_	_
	E2		



COMMON DIMENIONS

SYMBOL	P	IM	1
STMBUL	MIN	NDM	MAX
A	4.40	4.57	4.70
A1	1.27	1.30	1.37
A2	2.35	2.40	2.50
b	0.77	0.80	0.90
b2	1.17	1.27	1.36
c	0.48	0.50	0.56
D	15.40	15.60	15.80
D1	9.00	9.10	9.20
DEP	0.05	0.10	0.20
Ε	9.80	10.00	10.20
E1	-	8.70	-
E2	9.80	10.00	10.20
ØP1	1.40	1.50	1.60
e		2.54BS	0
e1		5.08BS	C
H1	6.40	6.50	6.60
L	12.75	13.50	13.65
LI	-	3.10	3.30
12		2.50REF	
ØP	3.50	3.60	3.63
Q	2.73	2.80	2.87
θ1	5	T	9.
θ2	ľ	3	5
63	1'	3	5'



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